50Ω DC-3000 MHz

Absorptive RF Switch with internal driver. Single Supply Voltage, +3V

Product Features

- Very Low Insertion loss over entire frequency range
- · Super High Isolation over entire frequency range
- High Input IP3, +55 dBm typ.
- Single positive supply voltage, +3V
- Very low DC current consumption, 8µA
- Immune to latch up
- Unique design-simultaneous switch off of RF1&RF2



HSWA2-30DR+

CASE STYLE: DG983-1

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Typical Applications

- Base Station Infrastructure
- Portable Wireless
- · CATV & DBS
- MMDS & Wireless LAN
- Band switch
- Diplexer switches
- · Bypass switches

General Description

The HSWA2-30DR+ is a 50 Ω high isolation SPDT RF switch designed for wireless applications, covering a broad frequency range from DC up to 3GHz with low insertion loss. The HSWA2-30DR+ operates on a single supply voltage +3V. See application note AN-80-006 for +5V supply voltage. This unit includes an internal CMOS control driver with two-pins control. The switch consumes very low supply current, 8 μ A typ. The HSWA2-30DR+ switch is in a very small size and low profile package, 4x4mm and 0.9mm respectively.



 Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance oriteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuit's tandard limited warranty and terms and conditions (collectively, "Standard Terms"). Purchasers of this part are entitle to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms "Standard Terms"); Purchasers of this part are entitled

minicircuits.com/MCLStore/terms.isp

Rev. J M151108 HSWA2-30DR+ 161213 Page 1 of 11

Mini-Circuits

HSWA2-30DR+

BE Electrical Specifications, DC-3000 MHz, TAMB=25°C, VDD=+3V

Parameter	Condition	Min.	Тур.	Max.	Units
Operating Frequency		DC ^(note 4)		3000	MHz
Insertion Loss ^(note 1)	1 GHz 2 GHz 3 GHz		0.75 0.95 1.2	1.0 1.2 1.4	dB
Isolation between Common port and RF1/RF2 ports	1 GHz 2 GHz 3 GHz	55 46 40	64 50 44		dB
Isolation between RF1 and RF2 ports	1 GHz 2 GHz 3 GHz	57 54 40	63 60 48		dB
Return Loss @ Common port	1 GHz 2 GHz 3 GHz		20 17 14		dB
Return Loss @ RF1/RF2 ports	1 GHz 2 GHz 3 GHz		20 18 17		dB
Input IP2	5 MHz - 1000 MHz		+80		dBm
Input IP3 ^(note 2)	10 MHz - 1000MHz 1000MHz - 3000MHz		+55 +52		dBm
Input 1dB Compression (note 2,3)	1000 MHz	+29	+31		dBm

Notes:

1. I.LOSS values are de-embedded from test board Loss.

2. Device linearity degrades below 1 MHz.

3. Note absolute maximum ratings for input power.

4. Lowest Freq. determined by value of coupling capacitors at RF ports.

DC Electrical Specifications

Parameter	Min.	Тур.	Max.	Units
VDD, Supply Voltage ^(note 5)	2.7	3	3.3	V
Supply Current $(V_{DD} = 3V)^{(note 6)}$	—	8	20	μA
Control Voltage Low	0	—	0.3xVdd	V
Control Voltage High	0.7xVdd	—	Vdd	V

Note 5: See application note AN-80-006 for +5V supply voltage.

Note 6: At Control Frequency of 1 kHz. Increases to 21 µA at 10 kHz and 56 µA at 50 kHz typically.

Switching Specifications

Parameter	Min.	Тур.	Max.	Units
Switching Time, 50% CTRL to 90/10% RF	-	2.0	-	μSec
Video Feedthrough, 5 MHz - 1000 MHz (note 7)	—	—	15	mV _{p·p}

Note 7: Measured with a 1 nSec risetime,0/3V pulse and 500 MHz bandwidth.

Absolute Maximum Ratings

Parameter	Ratings			
Operating Temperature	-40°C to 85°C			
Storage Temperature	-65°C to 150°C			
VDD, Supply Voltage	-0.3V Min., 4V Max.			
Voltage control	-0.3V Min., VDD + 0.3V Max.			
ESD, HBM (ANSI/ESD STM 5.1 - 2001)	250V to < 500V (CLASS 1A)			
ESD, MM (ANSI/ESD STM 5.2 - 1999)	50V (CLASS M1)			
RF input power: (note 8)				
When the common port is connected to the RF port (RF1 or RF2)	+33dBm			
When the RF port (RF1 or RF2) is not connected to the common port	+24dBm			
When the common port is not connected to either RF1 or RF2	+24dBm			

Note 8: See Truth Table on page 3.

Permanent damage may occur if any of these limits are exceeded.

Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuit's tandard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp



The RF switch control bits select the desired switch-state, as shown in **Table 1**: Truth Table.

Table 1: Truth Table.

STATE	Contro	l Input	RF Input / Output			
STATE	Control 1	Control 2	RF1 to RF COMMON	RF2 to RF COMMON		
1	Low	Low	OFF	OFF		
2	Low	High	OFF	ON		
3	High	Low	ON	OFF		
4	High	High	N/A	N/A		

General notes:

- 1. When either of the RF1 or RF2 ports is closed (ON state), the closed port is connected to the RF Common port.
- 2. When either of the RF1 or RF2 ports is open (OFF state), the open port is connected to an internal 50Ω termination.
- 3. When both RF1 and RF2 ports are open (OFF state), the all three RF ports are connected to an internal 50Ω termination.

EXAMPLE OF STATE 3

Functional Diagram



Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuit's tandard Terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp



Pin Description

Function	Pin Number	Description
GND	1	RF Ground
GND	2	RF Ground
RF1	3	RF I/O (note 1)
GND	4	RF Ground
GND	5	RF Ground
GND	6	RF Ground
GND	7	RF Ground
RF COM	8	RF Common (note 1)
GND	9	RF Ground
GND	10	RF Ground
GND	11	RF Ground
GND	12	RF Ground
RF2	13	RF I/O (note 1)
GND	14	RF Ground
GND	15	RF Ground
Control 2	16	Control 2
Control 1	17	Control 1
GND	18	Supply Voltage Ground
GND	19	Digital Ground
VDD	20	Supply Voltage
GND	Paddle	RF Ground Pad (note 2)

HSWA2-30DR+

Pin Configuration (Top View)



Notes:

1. RF pins 3, 8 and 13 must be at 0 VDC. The RF pins do not require DC blocking capacitors for proper operation if the 0 VDC requirement is met.

2. The exposed solder pad on the bottom of the package (See Pin Configuration) must be grounded for proper device operation

Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specification document are subject to Mini-Circuit's tandard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and thereudes, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jp



HSWA2-30DR+

Typical Performance Curves over various states. For switch state see Truth Table 1 on page 3.

INSERTION LOSS Vs. FREQUENCY @ +25°C

INSERTION LOSS Vs. FREQUENCY



Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuit's standard Terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp

Mini-Circuits

HSWA2-30DR+

Typical Performance Curves over various states. For switch state see Truth Table 1 on page 3.



RF COM RETURN LOSS Vs. FREQUENCY @ +25°C



Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuit's standard Terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp

Mini-Circuits

HSWA2-30DR+

Typical Performance Curves over various states. For switch state see Truth Table 1 on page 3.

RF2 RETURN LOSS Vs. FREQUENCY

RF2 RETURN LOSS Vs. FREQUENCY



Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuit's standard Terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp

Mini-Circuits

HSWA2-30DR+

Outline Drawing (DG983-1)



PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

Device Marking



Outline Dimensions (inch)

A	В	С	D	E	F	G	Н	J	К	L	М	N	Ρ	Q	R	WT. GRAMS
.157	.157	.035	.008	.081	.081	.010	_	.022	.020	.177	.177	.081	.010	.032	.081	.04
4.00	4.00	0.90	0.20	2.06	2.06	0.25	_	0.56	0.50	4.50	4.50	2.06	0.25	0.81	2.06	.04

Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuit's standard Terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp

Suggested Layout for PCB Design (PL-206)



DENOTES COPPER LAND PATTERN FREE OF SOLDERMASK

Recommended layout for PCB design

The amount of vias surrounding the device in the suggested PCB layout are critical for obtaining the specified isolation performance for the device shown in the datasheet.

Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuit's tandard Terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp



HSWA2-30DR+



How to use evaluation Board TB-347

TB-347

The Evaluation board TB-347 was designed to evaluate the electrical performance of the HSWA2-30DR+ SPDT switch.

RF3 and RF4 SMA 50 Ω connectors are connected through a 50 Ω transmission line that is used to estimate the evaluation board loss for de-embedding purposes. The transmission lines were designed using a coplanar waveguide with ground plane. For details, please see suggested PCB layout on Page 8. The number of vias surrounding the switch is critical for obtaining the specified isolation.

The TB-347 operates from +2.7V to +6.5V applied to VDD connector. IC1 voltage regulator limits the supply voltage to the switch to +3.3V. IC2 is a Schmitt trigger & buffer which prevents an overload of switch control inputs from high level control signals (up to +5.5V) and prevents from noise and transient spikes during switching process.

The control connector is used for computer control mode or manual operation mode. In manual control mode connect Control 1 and/or Control 2 to ground to set Control 1 and/or Control 2 to logic low, respectively. When jumpers are removed, the digital control input pulled up to VDD for logic high.

For computer control mode the software & cable are supplied. The cable should be connected between computer LPT port and evaluation board control connector.

Notes A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuit's standard limited warranty and terms and conditions. (Collectivel, "Standard Terms"): Purchasers of this part are entitled

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp





Tape and Reel Packaging Information

TR No.	No. of Devices	Reel Size	Tape Width	Pitch	Unit Orientation
	Small quantity standards 20, 50, 100, 200	7 inch			Tape
F87	3000 (Standard)	13 inch	12 mm	8 mm	Direction of Feed

Table T&R

Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuit's tandard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

